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INFORMATION		Atty. Docket No.: 150.00930102		Serial No.: 09/812,157		
DISCLOSURE STATEMENT				Confirmation No. 2941		
		Applicant(s): Marsh				
		Filing Date: March 19, 2001		Group: 2823		
<b>U.S. PATENT DOCUMENTS</b>						
Examiner Initial	Document Number	Date	Name	Class	SubClass	Filing Date If Appropriate
<del>JEH</del>	4,804,438	02/14/89	Rhodes	438	660	
<del>JEH</del>	5,372,849	12/13/94	McCormick et al.	427	253	
<del>JEH</del>	5,392,189	02/21/95	Fazan et al.	361	305	
<del>JEH</del>	5,489,548	02/06/96	Nishioka et al.	438	396	
<del>JEH</del>	5,665,628	09/09/97	Summerfelt	438	003	
<del>JEH</del>	5,981,390	11/09/99	Lee et al.	438	686	
<del>JEH</del>	6,030,847	02/29/00	Fazan et al.	438	003	
<del>JEH</del>	6,054,331	04/25/00	Woo et al.	438	603	
<del>JEH</del>	6,218,297	04/17/01	Marsh	438	654	
<b>FOREIGN PATENT DOCUMENTS</b>						
Document Number	Date	Country	Class	SubClass	Translation	
					Yes	No
NONE						
<b>OTHER DOCUMENTS (Including Authors, Title, Date, Pertinent Papers, etc.)</b>						
<del>JEH</del>		Gniewek et al., "Enhancement of Pt Adhesion Using a Si Underlay," <u>IBM Technical Disclosure Bulletin</u> , 20(3), 1009 (1977).				
<del>JEH</del>		Hofer et al., "Double Layer Lift-Off Process for Packaging," <u>IBM Technical Disclosure Bulletin</u> , 26(7B), 3771 (1983).				
<b>EXAMINER</b>		<b>Date Considered</b>				
Julien L. Haddad		05/22/2002				

\*Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.